15m 1765

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Mail Stop Amendment Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450



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(Date of Deposit)

James D. Wood

Name of person mailing Document or Fee

Signature

July 5, 2007

Date of Signature

Re: Application of:

Charles E. May

Serial No.:

09/943,196

Filed:

August 30, 2001

For:

Arrangement and Method for Fabricating A

Semiconductor Wafer

Group Art Unit:

1765

Examiner:

Lynette T. Umez-Eronini

Our Docket No.:

1003-0606

### TRANSMITTAL OF RESPONSE TO OFFICE ACTION

Please find for filing in connection with the above patent application the following:

- 1. Response to Office Action; and
- 2. One (1) return post card.

\* The fee has been calculated as shown below.

## CLAIMS AS AMENDED

	Claims Remaining After Amendment	Highest No. Paid For	Fee Calculation	Addit Fee
Total Claims	15	20	0 X 50	\$ 0.00
Independent Claims	3	3	0 X 200	\$ 0.00
Total Additional Fee Re	quired			\$ 0.00

Respectfully Submitted,

MAGINOT, MOORE & BECK LLP

July 5, 2007

James D. Wood

Registration No. 43,285

Chase Tower

111 Monument Circle, Suite 3250 Indianapolis, Indiana 46204-5109

**Enclosures** 

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Confirmation No.:

8500

Our Docket No.:

01-146/RCE (1003-0606)

# RESPONSE TO OFFICE ACTION

Sir:

In response to the Office Action dated April 5, 2007, please enter the following:

Amendments to the claims begin on page 2 of this paper; and

Remarks/Arguments begin on page 7 of this paper.